

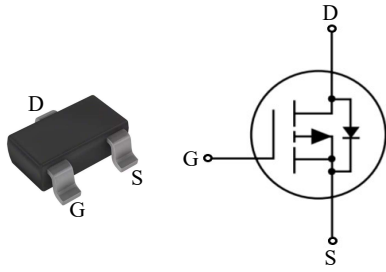


SM2319TDSH

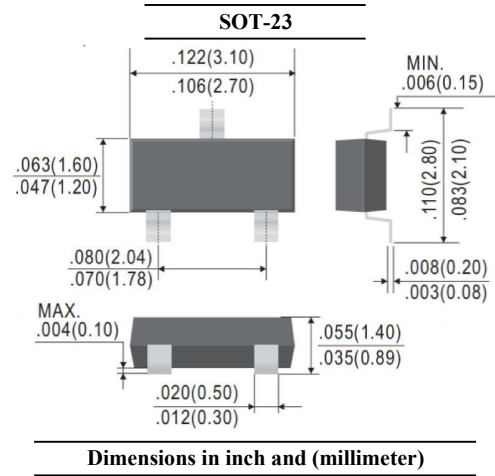
P-Channel Enhancement Mode Field Effect Transistor

FEATURES

- Fast Switching Speed
- Suffix "H" indicates Halogen-free parts, ex. SM2319TDSH



Pin	Description
G	Gate
S	Source
D	Drain



Maximum Ratings ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-40	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current	I_D	-4.2	A
Pulsed Drain Current (Note 1)	I_{DM}	-30	A
Power Dissipation	P_D	0.75	W
Thermal Resistance Junction to Ambient (Note 2)	$R_{\theta JA}$	$t = 5\text{ s}$	100
		Steady State	166
Operating and Storage Temperature Range	T_J, T_{stg}	- 55 to + 150	$^\circ\text{C}$

Note :

1. Pulse test : Pulse width $\leq 100\mu\text{s}$, duty cycle $\leq 2\%$, repetitive rating, pulse width limited by junction temperature $T_{J(MAX)} = 150^\circ\text{C}$
2. Device mounted on FR-4 substrate PC board, 2oz copper, with 1-inch square copper plate in still air



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Electrical Characteristics ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise specified)

Parameter	Conditions	Symbol	Min.	Typ.	Max.	Unit
Static						
Drain Source Breakdown Voltage	$I_D = -250\mu\text{A}$	V_{DSS}	-40	-	-	V
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	$V_{GS(th)}$	-1.0	-	-3.0	V
Zero Gate Voltage Drain Current	$V_{DS} = -40\text{V}$	I_{DSS}	-	-	-1	μA
Gate-Body Leakage Current	$V_{GS} = \pm 20\text{V}$	I_{GSS}	-	-	± 100	nA
Drain-Source On-State Resistance	$V_{GS} = -10\text{V}, I_D = -3.1\text{A}$	$R_{DS(on)}$	-	-	80	m Ω
	$V_{GS} = -4.5\text{V}, I_D = -2.6\text{A}$		-	-	120	
Forward Transconductance	$V_{DS} = -10\text{V}, I_D = -4.2\text{A}$	g_{FS}	-	7.6	-	S
Dynamic						
Gate Resistance	$V_{DS} = 0\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	R_g	-	4.6	-	Ω
Total Gate Charge	$V_{DS} = -20\text{V}, V_{GS} = -4.5\text{V}, I_D = -4.2\text{A}$	Q_g	-	9.0	-	nC
			-	20.0	-	
Gate-Source Charge	$V_{DS} = -20\text{V}, V_{GS} = -10\text{V}, I_D = -4.2\text{A}$	Q_{gs}	-	4.0	-	
Gate-Drain Charge		Q_{gd}	-	2.6	-	
Input Capacitance	$V_{DS} = -20\text{V}, V_{GS} = 0\text{V}, f = 1\text{MHz}$	C_{iss}	-	1179	-	pF
Output Capacitance		C_{oss}	-	82	-	
Reverse Transfer Capacitance		C_{rss}	-	40	-	
Turn-On Delay Time	$V_{GS} = -10\text{V}, V_{DD} = -20\text{V},$ $I_D = -4.2\text{A}, R_g = 6\Omega$	$t_{d(on)}$	-	15	-	ns
Turn-On Rise Time		t_r	-	28	-	
Turn-Off Delay Time		$t_{d(off)}$	-	19	-	
Turn-Off Fall Time		t_f	-	4	-	
Drain-Source Body Diode						
Drain-Source Diode Forward Voltage	$I_S = -1.3\text{A}, V_{GS} = 0\text{V}$	V_{SD}	-	-	-1.2	V
Reverse Recovery Time	$I_S = -4.2\text{A}, dI/dt = 100\text{A}/\mu\text{s}$	t_{rr}	-	13.3	-	ns
Reverse Recovery Charge		Q_{rr}	-	8.5	-	nC



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RATINGS AND CHARACTERISTIC CURVES

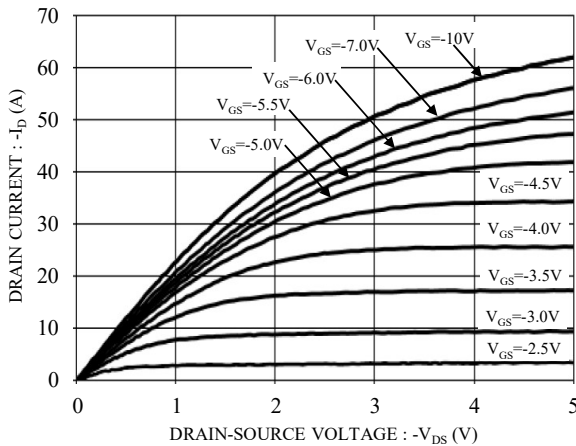


Fig.1 Typical Output Characteristics

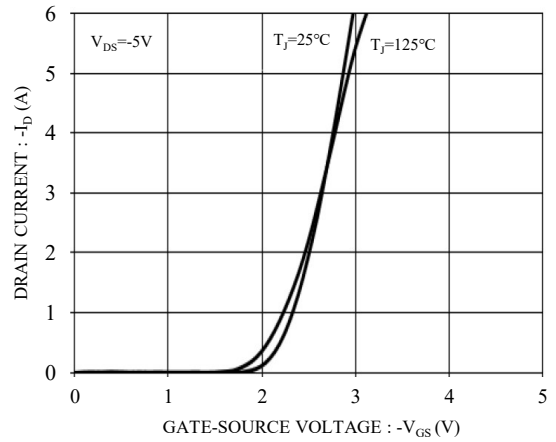


Fig.2 Typical Transfer Characteristics

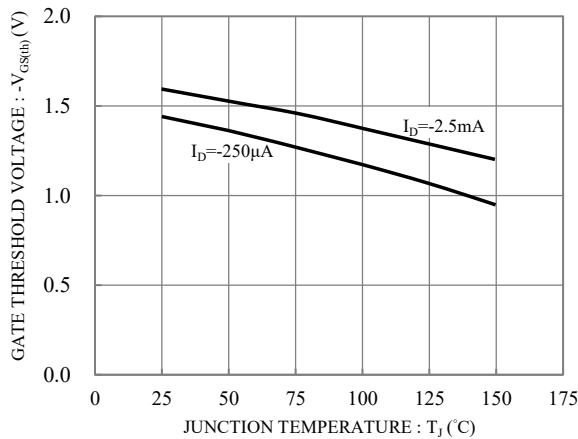


Fig.3 Gate Threshold Voltage vs. Junction Temperature

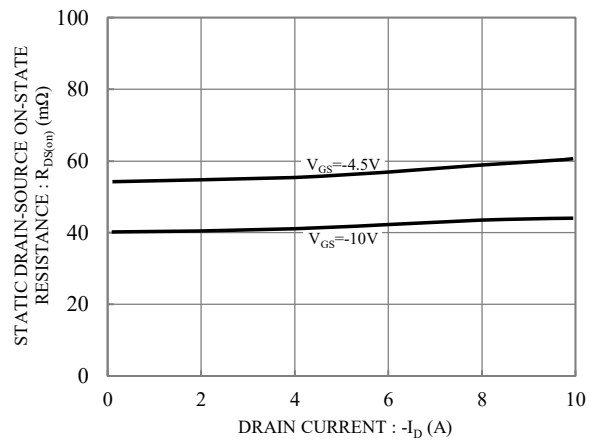


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current

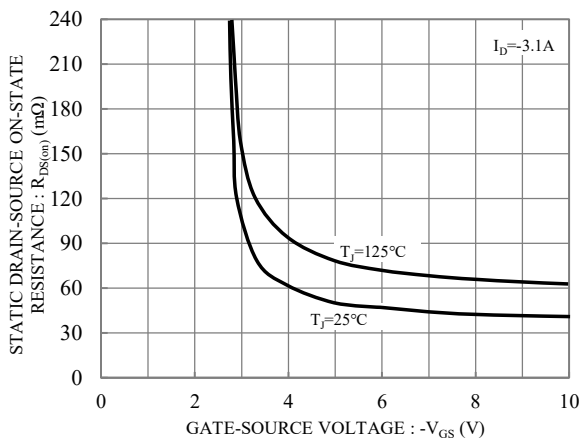


Fig.5 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

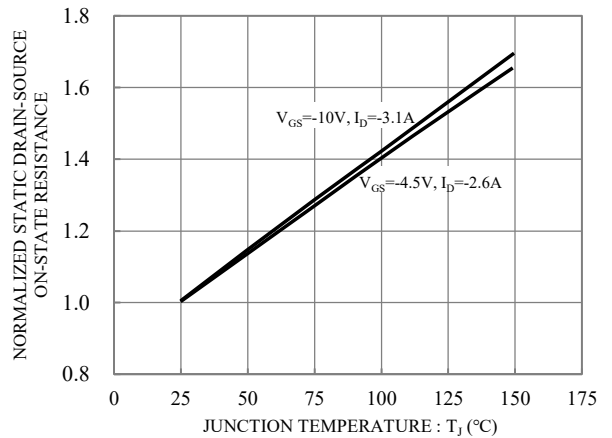


Fig.6 Normalized Static Drain-Source On-state Resistance vs. Junction Temperature



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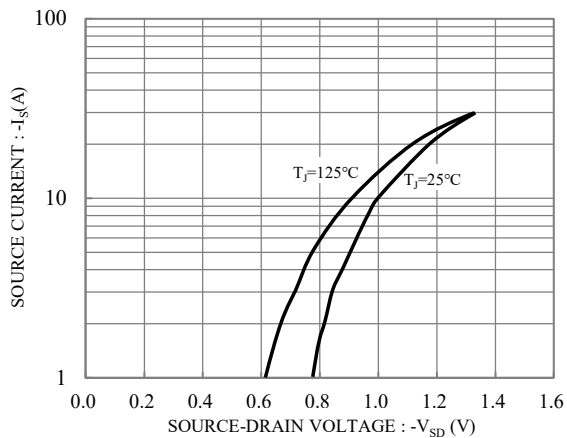


Fig.7 Diode Forward Voltage vs. Source Current

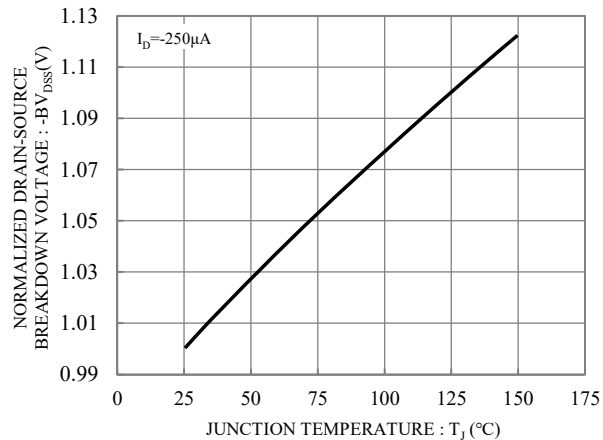


Fig.8 Breakdown Voltage vs. Junction Temperature

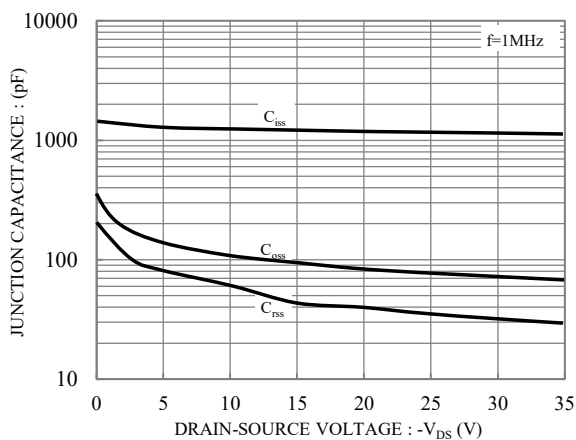


Fig.9 Capacitance vs. Drain-Source Voltage

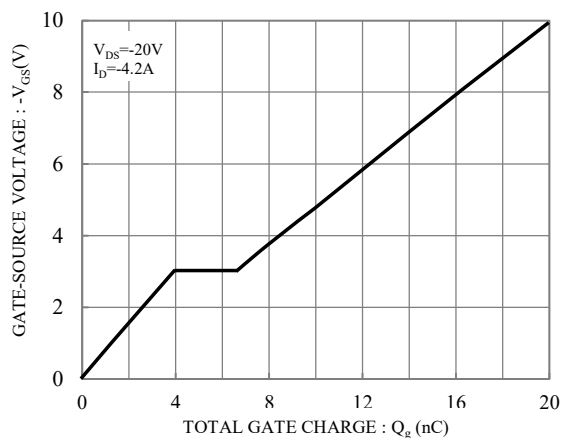


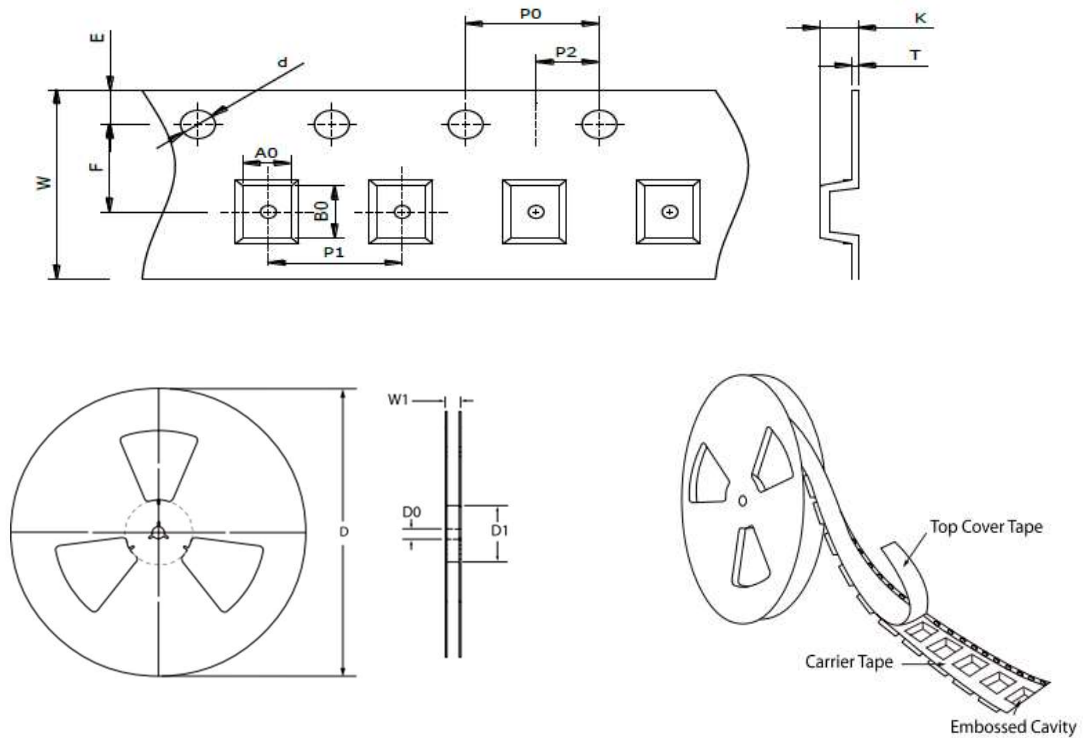
Fig.10 Gate Charge Characteristics



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TAPE & REEL SPECIFICATION



Item	Symbol	SOT-23
Carrier width	A ₀	3.20 ± 0.10
Carrier length	B ₀	2.90 ± 0.10
Carrier depth	K	1.50 ± 0.10
Sprocket hole	d	1.50 ± 0.10
Reel outside diameter	D	178.00 ± 2.00
Feed hole width	D ₀	13.00 ± 0.50
Reel inner diameter	D ₁	MIN. 50.00
Sprocket hole position	E	1.75 ± 0.10
Punch hole position	F	3.50 ± 0.10
Sprocket hole pitch	P ₀	4.00 ± 0.10
Punch hole pitch	P ₁	4.00 ± 0.10
Embossment center	P ₂	2.00 ± 0.10
Overall tape thickness	T	0.20 ± 0.05
Tape width	W	8.00 ± 0.20
Reel width	W1	MAX. 14.50

ORDER INFORMATION

Package	Reel Size	Quantity
SOT-23	7"	3,000

MARKING CODE

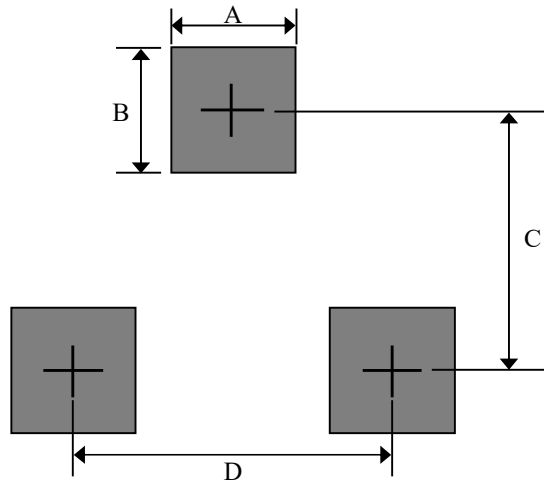
Part Number	Marking Code
SM2319TDSH	UJ



SM2319TDSH

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SUGGESTED SOLDER PAD LAYOUT



Unit : mm

PACKAGE	A	B	C	D
SOT-23	0.80	1.00	2.40	1.90